



Editorial Board Members' Collection Series: Plasma Techniques

Guest Editor:

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Deadline for manuscript
submissions:

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Message from the Guest Editor

Dear Colleagues,

We are pleased to announce this collection titled “Editorial Board Members’ Collection Series: Plasma Techniques”. This issue will be a collection of papers, and researchers invited by the Editorial Board Members.

The aim is to provide a venue for networking and communication between *Applied Sciences* and scholars in the field of Plasma Techniques. All papers will be published with full open access after peer review.

Dr. Heping Li
Guest Editor





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Editor-in-Chief

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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